Features:

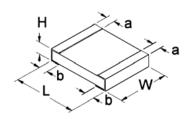
- Gold terminations are completely impervious to sulfur
- Zero ohm available (max resistance 0.05Ω)
- RoHS compliant, REACH compliant and halogen free



Electrical Specifications							
Type / Code	Power Rating (W) @ 70°C	Maximum Working Voltage (V) ⁽¹⁾	Maximum Overload Voltage (V)	TCR (ppm/ºC)	Ohmic Range (Ω	2) and Tolerance	
				-0/+600	1 -	3.6	
RMCG0402	0.4	50	100	± 350	3.9	- 9.1	
RMCG0402	0.1	50	100	± 200	10 -	· 1M	
				± 350	1.1M	- 10M	
				± 350	1 -	9.1	
RMCG0603	0.1	50	100	± 200	10 -	· 1M	
				± 350		- 10M	
				± 350		3.6	
				± 250	3.9		
RMCG0805	0.125	150	300	± 200		· 1M	
		.00		± 250	1.1M - 5.1M		
				± 350	5.6M	- 10M	
				± 350	1 - 3.6		
	0.25	200		± 250	3.9 - 9.1		
RMCG1206			400	± 200		· 1M	
				± 250	1.1M - 5.1M		
				± 350	5.6M	- 10M	
				± 350	1 -	3.6	
	0.33		400	± 250	3.9 - 9.1		
RMCG1210		200		± 200		· 1M	
				± 250	1.1M - 5.1M		
				± 350	5.6M	- 10M	
				± 350	1 - 2	1 - 3.6	
				± 250	2.2 - 9.1	3.9 - 9.1	
RMCG2010	0.75	200	400	± 200		· 1M	
				± 250		- 5.1M	
				± 350	5.6M	- 10M	
				± 350	1 -	3.6	
				± 250	3.9		
RMCG2512	1	200	400	± 200		· 1M	
				± 250		- 5.1M	
(4)				± 350	5.6M	- 10M	

⁽¹⁾ Lesser of $\sqrt{P^*R}$ or maximum working voltage.

Mechanical Specifications



Type / Code	L Body Length	W Body Width	H Body Height	a Top Termination	b Bottom Termination	Unit
RMCG0402	0.039 ± 0.002	0.020 ± 0.002	0.014 ± 0.002	0.008 ± 0.004	0.010 ± 0.004	inches
	1.00 ± 0.05	0.50 ± 0.05	0.35 ± 0.05	0.20 ± 0.10	0.25 ± 0.10	mm
RMCG0603	0.063 ± 0.004	0.031 ± 0.004	0.018 ± 0.004	0.012 ± 0.008	0.012 ± 0.008	inches
	1.60 ± 0.10	0.80 ± 0.10	0.45 ± 0.10	0.30 ± 0.20	0.30 ± 0.20	mm
RMCG0805	0.079 ± 0.008	0.049 ± 0.004	0.020 ± 0.006	0.016 ± 0.008	0.016 ± 0.008	inches
	2.00 ± 0.20	1.25 ± 0.10	0.50 ± 0.15	0.40 ± 0.20	0.40 ± 0.20	mm
RMCG1206	0.126 ± 0.008	0.063 ± 0.006	0.022 ± 0.006	0.020 ± 0.010	0.020 ± 0.010	inches
	3.20 ± 0.20	1.60 ± 0.15	0.55 ± 0.15	0.50 ± 0.25	0.50 ± 0.25	mm
RMCG1210	0.126 ± 0.008	0.098 ± 0.008	0.022 ± 0.006	0.020 ± 0.010	0.020 ± 0.010	inches
	3.20 ± 0.20	2.50 ± 0.20	0.55 ± 0.15	0.50 ± 0.25	0.50 ± 0.25	mm
RMCG2010	0.197 ± 0.008	0.098 ± 0.008	0.022 ± 0.006	0.024 ± 0.010	0.024 ± 0.010	inches
	5.00 ± 0.20	2.50 ± 0.20	0.55 ± 0.15	0.60 ± 0.25	0.60 ± 0.25	mm
RMCG2512	0.248 ± 0.008	0.126 ± 0.008	0.022 ± 0.006	0.024 ± 0.010	0.024 ± 0.010	inches
	6.30 ± 0.20	3.20 ± 0.20	0.55 ± 0.15	0.60 ± 0.25	0.60 ± 0.25	mm

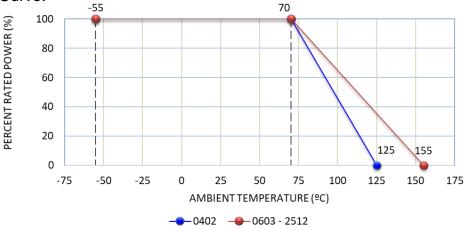
Performance Characteristics								
Test	Test Conditions (JIS C 5202)	Test Results						
Short Time Overload	2.5x rated voltage for 5 seconds	± (2% + 0.1 Ω)						
Dielectric Withstanding Voltage	100 VAC, 1 minute	± (1% + 0.05 Ω)						
Resistance to Soldering Heat	$260^{\circ}\text{C} \pm 5^{\circ}\text{C}$, for 10 seconds ± 0.5 seconds (solder bath)	± (1% + 0.05 Ω)						
Solderability	$245^{\circ}\text{C} \pm 5^{\circ}\text{C}$, for 3 seconds ± 0.5 seconds (colophonium flux)	95% coverage, minimum						
Temperature Cycle (100 cycles)	-55°C: 30 minutes 25°C: 2 to 3 minutes 125°C: 30 minutes 25°C: 2 to 3 minutes	± (1% + 0.05 Ω) Jumper (< 0.05 Ω)						
Endurance (Damp load)	$60^{\circ}\text{C} \pm 2^{\circ}\text{C}$, 90% RH, Rated Load 90 minutes On, 30 minutes Off (1000 hours -0 hours +48 hours)	± (3% + 0.1 Ω) Jumper (< 0.05 Ω)						
Endurance (Rated load)	70°C ± 2°C, Rated Load 90 minutes On, 30 minutes Off (1000 hours -0 hours +48 hours)	± (3% + 0.1 Ω) Jumper (< 0.05 Ω)						
Voltage Coefficient	1/10 rated voltage for 3 second, then rated voltage for 3 seconds	± 100 (ppm/V)						
Robustness of Termination	Bend of 3 mm for 5 ± 1 seconds	± (1% + 0.05 Ω)						

Operating Temperature Range: -55°C to +125°C (0402)

-55°C to +155°C (0603 - 2512)

2

Power Derating Curve:



Recommended Solder Profile

This information is intended as a reference for solder profiles for Stackpole resistive components. These profiles should be compatible with most soldering processes. These are only recommendations. Actual numbers will depend on board density, geometry, packages used, etc., especially those cells labeled with "*".

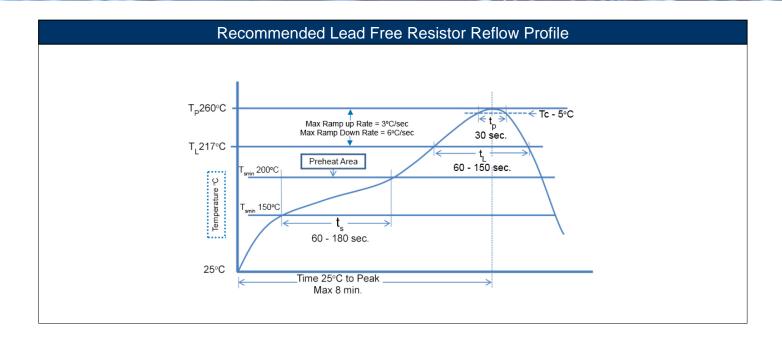
100% Matte Tin / RoHS Compliant Terminations

Soldering iron recommended temperatures: 330°C to 350°C with minimum duration. Maximum number of reflow cycles: 3.

Wave Soldering								
Description Maximum Recommended Minimum								
Preheat Time	80 seconds	70 seconds	60 seconds					
Temperature Diff.	140°C	120°C	100°C					
Solder Temp.	260°C	250°C	240°C					
Dwell Time at Max	10 seconds	5 seconds	*					
Ramp DN (°C/sec)	N/A	N/A	N/A					

Temperature Diff. = Difference between final preheat stage and soldering stage.

Convection IR Reflow							
Description Maximum Recommended Minimum							
Ramp Up (°C/sec)	3°C/sec	2°C/sec	*				
Dwell Time > 217°C	150 seconds	90 seconds	60 seconds				
Solder Temp.	260°C	245°C	*				
Dwell Time at Max.	30 seconds	15 seconds	10 seconds				
Ramp DN (°C/sec)	6°C/sec	3°C/sec	*				



Part Marking Instructions



1% Marking nal resistance is ma

The nominal resistance is marked on the surface of the overcoating with the use of 4 digit markings.

0201 and 0402 are not marked.



5% Marking

The nominal resistance is marked on the surface of the overcoating with the use of 3 digit markings.

0201 and 0402 are not marked.

For shared E24/E96 values, 1% tolerance product may be marked with three-digit marking instead of the standard four-digit marking for all other E96 values. All E24 values available in 1% tolerance are also marked with three-digit marking.

Marking Instructions for 0603 1% Chip Resistors (per EIA-J)

A two-digit number is assigned to each standard R-Value (E96) as shown in the chart below. This is followed by one alpha character which is used as a multiplier. Each letter represents a specific multiplier as follows:

Z = 0.01	A = 10	D = 10,000
Y = 0.1	B = 100	E = 100,000
X = 1	C = 1,000	F = 1,000,000

EXAMPLE:

Chip Marking	Explanation	Value		
01B	01 means 10.0 and B = 100	10.0 x 100 = 1 Kohm		
25C	25 means 17.8 and C = 1,000	17.8 x 1,000 = 17.8 Kohm		
93D	93 means 90.9 and D = 10,000	90.9 x 10,000 = 909 Kohm		

	E96										
#	R-Value										
01	10.0	17	14.7	33	21.5	49	31.6	65	46.4	81	68.1
02	10.2	18	15.0	34	22.1	50	32.4	66	47.5	82	69.8
03	10.5	19	15.4	35	22.6	51	33.2	67	48.7	83	71.5
04	10.7	20	15.8	36	23.2	52	34.0	68	49.9	84	73.2
05	11.0	21	16.2	37	23.7	53	34.8	69	51.1	85	75.0
06	11.3	22	16.5	38	24.3	54	35.7	70	52.3	86	76.8
07	11.5	23	16.9	39	24.9	55	36.5	71	53.6	87	78.7
08	11.8	24	17.4	40	25.5	56	37.4	72	54.9	88	80.6
09	12.1	25	17.8	41	26.1	57	38.3	73	56.2	89	82.5
10	12.4	26	18.2	42	26.7	58	39.2	74	57.6	90	84.5
11	12.7	27	18.7	43	27.4	59	40.2	75	59.0	91	86.6
12	13.0	28	19.1	44	28.0	60	41.2	76	60.4	92	88.7
13	13.3	29	19.6	45	28.7	61	42.2	77	61.9	93	90.9
14	13.7	30	20.0	46	29.4	62	43.2	78	63.4	94	93.1
15	14.0	31	20.5	47	30.1	63	44.2	79	64.9	95	95.3
16	14.3	32	21.0	48	30.9	64	45.3	80	66.5	96	97.6

RoHS Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union's directive regarding "Restrictions on Hazardous Substances" (RoHS 3). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament as amended by Directive (EU) 2015/863/EU as regards the list of restricted substances.

	RoHS Compliance Status								
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)			
RMCG	Gold Barrier Thick Film Surface Mount Chip Resistor	SMD	YES(1)	100% Matte Sn over Ni	Jan-06	06/01			

Note (1): RoHS Compliant by means of exemption 7c-I.

"Conflict Metals" Commitment

We at Stackpole Electronics, Inc. are joined with our industry in opposing the use of metals mined in the "conflict region" of the Eastern Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

Compliance to "REACH"

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, "The Registration, Evaluation, Authorization and Restriction of Chemicals", otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

Environmental Policy

It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.

